



AF/2828

THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Bernd Borchert
Serial No.: 09/944,823
Filed: August 31, 2001
For: SEMICONDUCTOR LASER CHIP AND METHOD FOR
FABRICATING A SEMICONDUCTOR LASER CHIP
Confirmation No.: 3378
Group Art Unit: 2828
Examiner: Delma R. Flores Ruiz
Attorney Docket No.: 32226.12
Additional Fees: Charge to Deposit Account 023732

Mail Stop Non-Fee Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

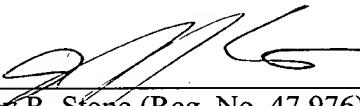
TRANSMITTAL COVER LETTER

Enclosed for filing, please find the following:

1. Amendment and Response (4 pages); and
2. Postcard receipt.

Respectfully submitted,

Dated: 3/2/04

By 
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CERTIFICATE OF MAILING

I hereby certify that this document, along with the documents referenced above, are being deposited with the United States Postal Service as First Class Mail, in an envelope addressed to: Mail Stop Non-Fee Amendment, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450 on the date indicated below.

By: Evin A. Asfeld
Date: 3/2/04